APR 3 0 2003

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Whonchee Lee et al.

APPLICATION NO.:

09/887,767

FILED:

June 21, 2001

For:

MICROELECTRONIC SUBSTRATE

HAVING CONDUCTIVE MATERIAL WITH BLUNT CORNERED APERTURES, AND

ASSOCIATED METHODS FOR

REMOVING CONDUCTIVE MATERIAL

EXAMINER: Alvin J. Grant

ART UNIT:

3723

CONF. No: 9072

#12 DS

Supplemental Information Disclosure Statement
As Submission Under 37 C.F.R. § 1.114

RECEIVED
MAY 0 \$ 2003

Box RCE Commissioner for Patents Washington, D.C. 20231

TECHNOLOGY CENTER R3700

Sir:

1. <u>Timing of Submission</u>

This information disclosure is being filed with a Request for Continued Examination under 37 C.F.R. § 1.114. The references listed on the enclosed Form PTO-1449 (modified) may be material to the examination of this application; the Examiner is requested to make them of record in the application.

2. Cited Information

\boxtimes	Copies of the following references are enclosed:		
		All cited references References marked by asterisks The following:	
	Copies of the following references can be found in parent U.S. Application No.:		
		All cited references References marked by asterisks The following:	
	The following references are not in English. For each such reference, the undersigned has enclosed (i) a translation of the reference; (ii) a copy of a communication from a foreign patent office or International Searching Authority citing the reference. (iii) a copy of a reference which appears to be an English		

language counterpart, or (iv) an English-language abstract for the reference prepared by a third party. Applicant has not verified that the translation,

Attorney Docket No. 108298515US2 Disclosure No. 00-0999

English-language counterpart or third-party abstract is an accurate representation of the teachings of the non-English reference, though, and reserves the right to demonstrate otherwise.

	All cited references
	References marked by a pound sign (#)
\boxtimes	The following: JP 2001077117 A1

3. Effect of Information Disclosure Statement (37 CFR 1.97(h))

This Information Disclosure Statement is not to be construed as a representation that: (i) a search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the cited information is, or is considered to be, material to patentability. In addition, applicant does not admit that any enclosed item of information constitutes prior art to the subject invention and specifically reserves the right to demonstrate that any such reference is not prior art.

4. Fee Payment

No fees are believed due. However, should the Commissioner determine that fees are due in order for this Information Disclosure Statement to be considered, the Commissioner is hereby authorized to charge such fees to Deposit Account No. 50-0665.

5. Patent Term Adjustment (37 CFR 1.704(d))

The undersigned states that each item of information submitted herewith was cited in a communication from a foreign patent office in a counterpart application and that this communication was not received by any individual designated in 37 C.F.R. § 1.56(c) more than thirty days prior to the filing of this statement. 37 C.F.R. § 1.704(d).

Respectfully submitted,

Perkins Coie LLP

Date: 400 30, 2003

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